

GTT3434**N-CHANNEL ENHANCEMENT MODE POWER MOSFET**

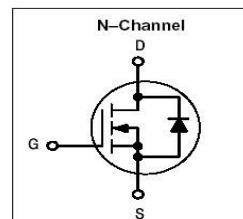
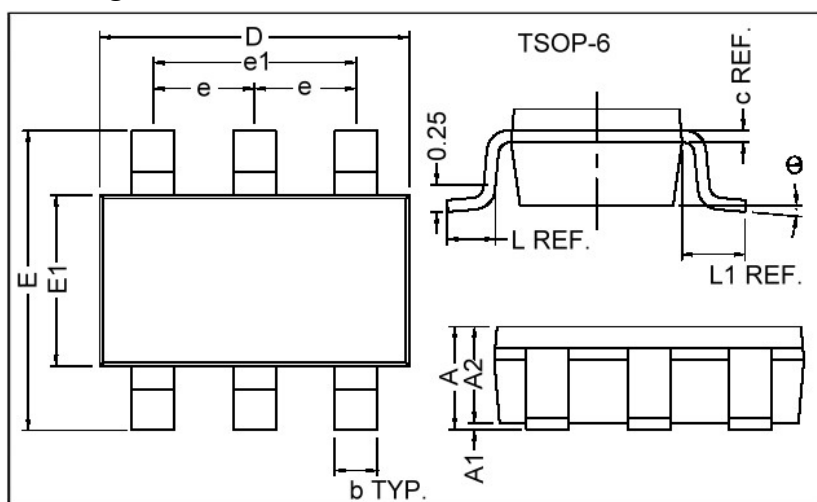
BV _{DSS}	30V
R _{DS(ON)}	34mΩ
I _D	6.1A

Description

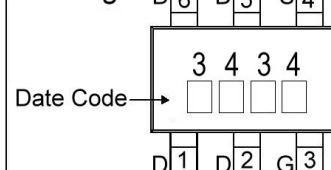
The GTT3434 uses advanced trench technology to provide excellent on-resistance and low gate charge. The TSSOP-6 package is universally used for all commercial-industrial surface mount applications.

Features

- * Low on-resistance
- *Capable of 2.5V gate drive

**Package Dimensions**

Marking : D 6 D 5 S 4



REF.	Millimeter		REF.	Millimeter	
	Min.	Max.		Min.	Max.
A	1.10 MAX.		L	0.45 REF.	
A1	0	0.10	L1	0.60 REF.	
A2	0.70	1.00	θ	0°	10°
c	0.12 REF.		b	0.30	0.50
D	2.70	3.10	e	0.95 REF.	
E	2.60	3.00	e1	1.90 REF.	
E1	1.40	1.80			

Absolute Maximum Ratings

Parameter	Symbol	Ratings	Unit
Drain-Source Voltage	V _{DS}	30	V
Gate-Source Voltage	V _{GS}	±12	V
Continuous Drain Current ³ , V _{GS} @4.5V	I _D @TA=25°C	6.1	A
Continuous Drain Current ³ , V _{GS} @4.5V	I _D @TA=70°C	4.9	A
Pulsed Drain Current ¹	I _{DM}	30	A
Total Power Dissipation	P _D @TA=25°C	1.14	W
Linear Derating Factor		0.01	W/°C
Operating Junction and Storage Temperature Range	T _j , T _{stg}	-55 ~ +150	°C

Thermal Data

Parameter	Symbol	Value	Unit
Thermal Resistance Junction-ambient ³ Max.	R _{thj-a}	110	°C/W

Electrical Characteristics (T_j = 25°C unless otherwise specified)

Parameter	Symbol	Min.	Typ.	Max.	Unit	Test Conditions
Drain-Source Breakdown Voltage	BV _{DSS}	30	-	-	V	V _{GS} =0, I _D =250uA
Gate Threshold Voltage	V _{GS(th)}	0.6	-	-	V	V _{DS} =V _{GS} , I _D =1mA
Forward Transconductance	g _{fs}	-	20	-	S	V _{DS} =10V, I _D =6.1A
Gate-Source Leakage Current	I _{GSS}	-	-	±100	nA	V _{GS} = ±12V
Drain-Source Leakage Current(T _j =25°C)	I _{DSS}	-	-	1	uA	V _{DS} =30V, V _{GS} =0
Drain-Source Leakage Current(T _j =70°C)		-	-	5	uA	V _{DS} =24V, V _{GS} =0
Static Drain-Source On-Resistance ²	R _{DS(ON)}	-	-	34	mΩ	V _{GS} =4.5V, I _D =6.1A
		-	-	50		V _{GS} =2.5V, I _D =2.0A
Total Gate Charge ²	Q _g	-	8	12	nC	I _D =6.1A V _{DS} =15V V _{GS} =4.5V
Gate-Source Charge	Q _{gs}	-	1.9	-		
Gate-Drain ("Miller") Charge	Q _{gd}	-	2.6	-		
Turn-on Delay Time ²	T _{d(on)}	-	21	-	ns	V _{DS} =15V I _D =1A V _{GS} =4.5V R _G =6Ω R _L =15Ω
Rise Time	T _r	-	45	-		
Turn-off Delay Time	T _{d(off)}	-	40	-		
Fall Time	T _f	-	30	-		

Source-Drain Diode

Parameter	Symbol	Min.	Typ.	Max.	Unit	Test Conditions
Forward On Voltage ²	V _{SD}	-	-	1.2	V	I _S =1.7A, V _{GS} =0V
Reverse Recovery Time ²	T _{rr}	-	40	-	ns	I _S =1.7A, dI/dt=100A/μs

Notes: 1. Pulse width limited by Max. junction temperature.

2. Pulse width ≤ 300us, duty cycle ≤ 2%.

3. Surface mounted on 1 in² copper pad of FR4 board, t ≤ 5sec; 180°C/W when mounted on Min. copper pad.

Characteristics Curve

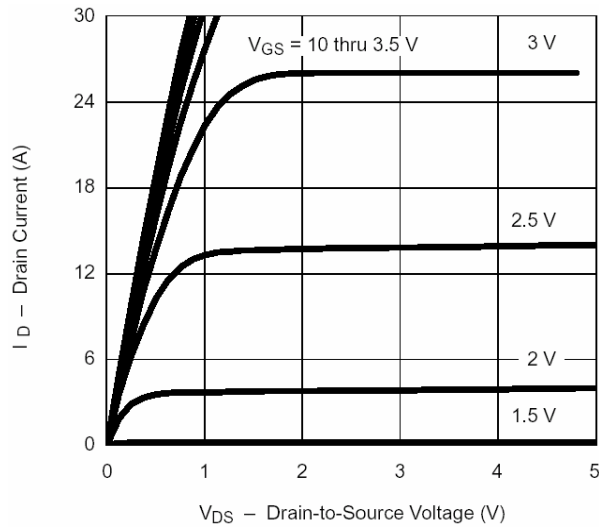


Fig 1. Typical Output Characteristics

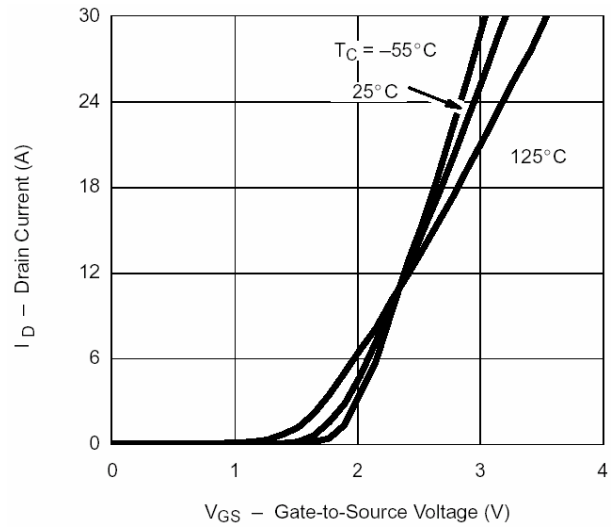


Fig 2. Transfer Characteristics

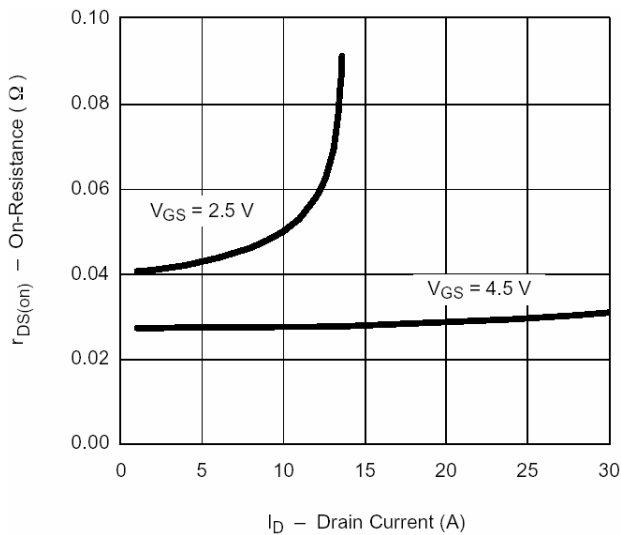
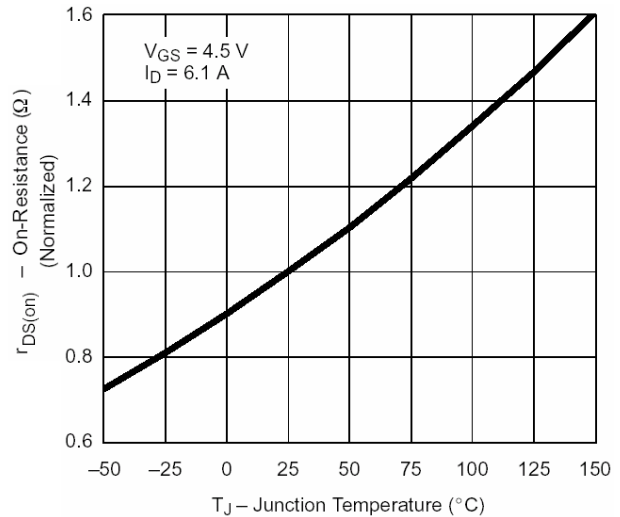
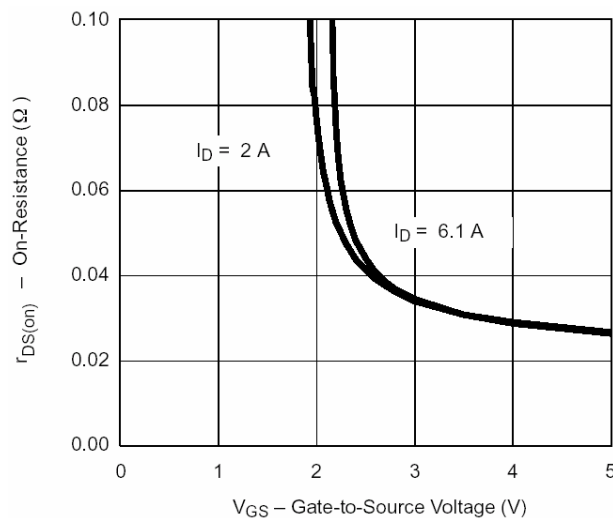


Fig 3. On-Resistance v.s. Drain Current



**Fig 4. On-Resistance
v.s. Junction Temperature**



**Fig 5. On-Resistance
v.s. Gate-Source Voltage**

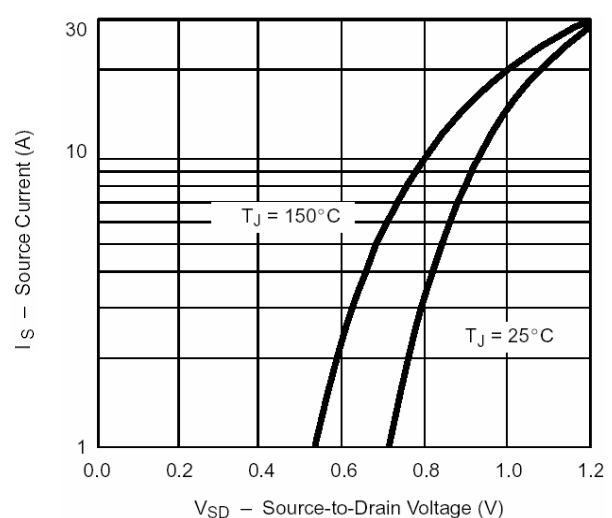


Fig 6. Body Diode Characteristics

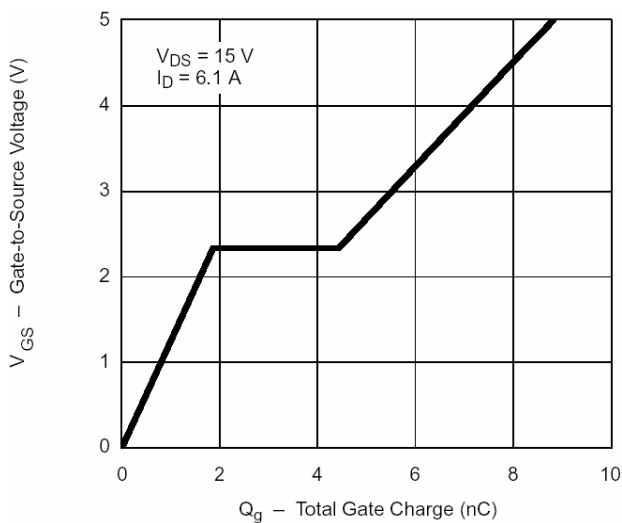


Fig 7. Gate Charge Characteristics

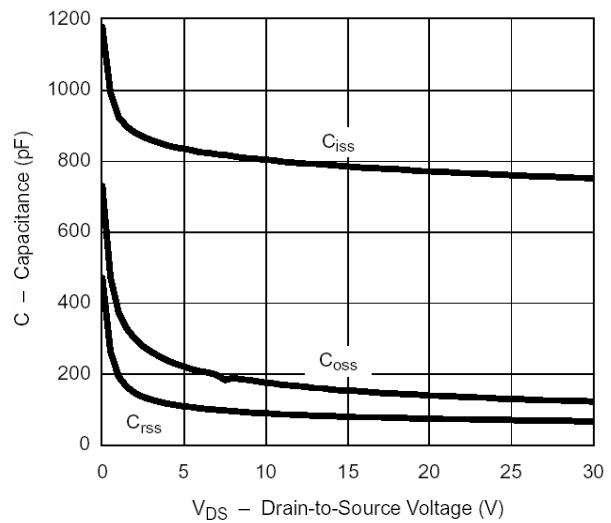


Fig 8. Typical Capacitance Characteristics

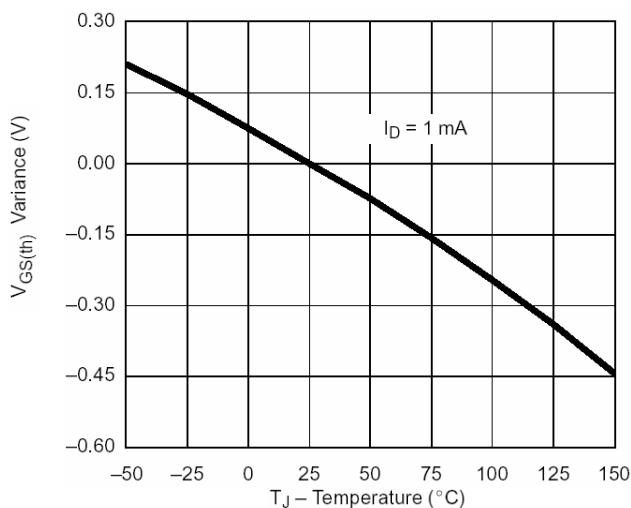


Fig 9. Threshold Voltage

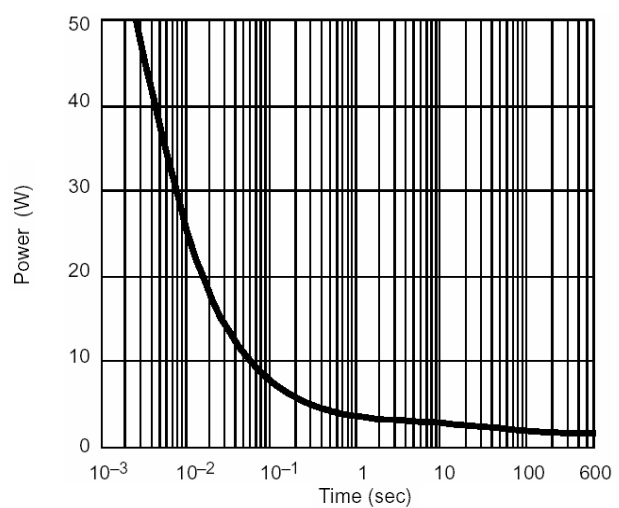


Fig 10. Single Pulse Power

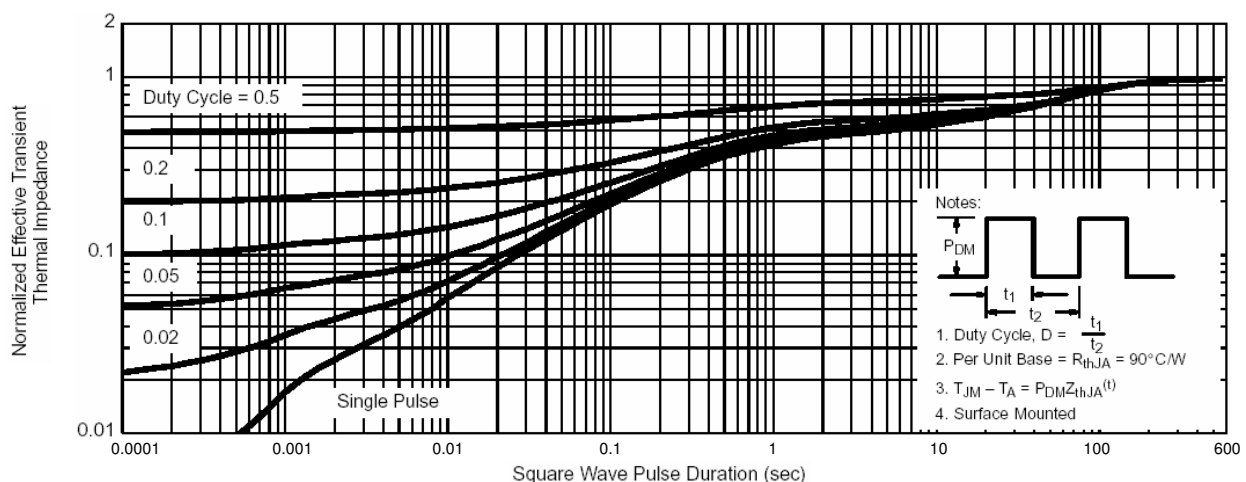


Fig 11. Normalized Maximum Transient Thermal Impedance

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